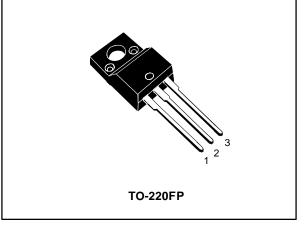
# STF28N60DM2

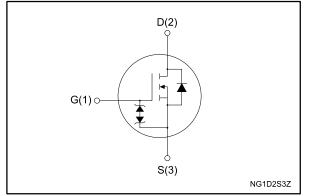


# N-channel 600 V, 0.13 Ω typ., 21 A MDmesh<sup>™</sup> DM2 Power MOSFET in a TO-220FP package

Datasheet - production data



### Figure 1: Internal schematic diagram



This is information on a product in full production.

## **Features**

Order code	V <sub>DS</sub> @ T <sub>Jmax.</sub>	R <sub>DS(on)</sub> max.	ID	Ртот
STF28N60DM2	650 V	0.16 Ω	21 A	30 W

- Fast-recovery body diode
- Extremely low gate charge and input capacitance
- Low on-resistance
- 100% avalanche tested
- Extremely high dv/dt ruggedness
- Zener-protected

## **Applications**

• Switching applications

## Description

This high voltage N-channel Power MOSFET is part of the MDmesh<sup>™</sup> DM2 fast recovery diode series. It offers very low recovery charge (Qrr) and time (trr) combined with low R<sub>DS(on)</sub>, rendering it suitable for the most demanding high efficiency converters and ideal for bridge topologies and ZVS phase-shift converters.

#### Table 1: Device summary

· · · · · · · · · · · · · · · · · · ·				
Order code	Marking	Package	Packing	
STF28N60DM2	28N60DM2	TO-220FP	Tube	

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### Contents

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# 1 Electrical ratings

Table 2: Absolute maximum ratings

Symbol	Parameter	Value	Unit
Vgs	Gate-source voltage	±25	V
1-	Drain current (continuous) at T <sub>case</sub> = 25 °C	21	٨
lo	Drain current (continuous) at T <sub>case</sub> = 100 °C	14	A
IDM <sup>(1)</sup>	Drain current (pulsed)	84	А
Ртот	Total dissipation at T <sub>case</sub> = 25 °C	30	W
dv/dt <sup>(2)</sup>	Peak diode recovery voltage slope	50	V/ns
dv/dt <sup>(3)</sup>	MOSFET dv/dt ruggedness	50	v/ns
Viso <sup>(4)</sup>	Insulation withstand voltage (RMS) from all three leads to external heat sink	2.5	kV
T <sub>stg</sub>	Storage temperature	55 to 150	°C
Tj	Operating junction temperature	-55 to 150	°C

#### Notes:

 $^{\left( 1\right) }$  Pulse width is limited by safe operating area.

 $^{(2)}$  Isp  $\leq$  21 A, di/dt=900 A/µs; Vps peak < V(BR)pss,Vpp = 400 V

 $^{(3)}$  V<sub>DS</sub>  $\leq$  480 V.

<sup>(4)</sup>t = 1 s; Tc = 25 °C

#### Table 3: Thermal data

Symbol	Parameter	Value	Unit		
R <sub>thj-case</sub>	Thermal resistance junction-case	4.2	°C 11/		
Rthj-amb	Thermal resistance junction-ambient	62.5	°C/W		

#### **Table 4: Avalanche characteristics**

Symbol	Parameter	Value	Unit
lar <sup>(1)</sup>	Avalanche current, repetitive or not repetitive	4	А
E <sub>AS</sub> <sup>(2)</sup>	Single pulse avalanche energy	350	mJ

#### Notes:

<sup>(1)</sup> pulse width limited by T<sub>jmax</sub>

 $^{(2)}$  starting  $T_{j}$  = 25 °C,  $I_{D}$  =  $I_{AR},\,V_{DD}$  = 50 V.



# 2 Electrical characteristics

(T<sub>case</sub> = 25 °C unless otherwise specified)

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
$V_{(BR)DSS}$	Drain-source breakdown voltage	$V_{GS}$ = 0 V, $I_D$ = 1 mA	600			V
	Zoro goto voltago	$V_{GS} = 0 V, V_{DS} = 600 V$			1	
IDSS	Zero gate voltage drain current	V <sub>GS</sub> = 0 V, V <sub>DS</sub> = 600 V, T <sub>case</sub> = 125 °C			100	μA
lgss	Gate-body leakage current	$V_{DS} = 0 V$ , $V_{GS} = \pm 25 V$			±10	μA
$V_{\text{GS(th)}}$	Gate threshold voltage	$V_{DS} = V_{GS}$ , $I_D = 250 \ \mu A$	3	4	5	V
R <sub>DS(on)</sub>	Static drain-source on-resistance	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 10.5 \text{ A}$		0.13	0.16	Ω

Table 6: Dynamic						
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
Ciss	Input capacitance		-	1500	-	
Coss	Output capacitance	V <sub>DS</sub> = 100 V, f = 1 MHz,	-	70	-	pF
Crss	Reverse transfer capacitance	V <sub>GS</sub> = 0 V	-	1.6	-	P
Coss eq. <sup>(1)</sup>	Equivalent output capacitance	$V_{DS} = 0$ to 480 V, $V_{GS} = 0$ V	-	134	-	pF
Rg	Intrinsic gate resistance	f = 1 MHz, I <sub>D</sub> = 0 A	-	4.6	-	Ω
Qg	Total gate charge	$V_{DD} = 480 \text{ V}, I_D = 21 \text{ A},$	-	34	-	
Qgs	Gate-source charge	V <sub>GS</sub> = 10 V (see Figure 15: "Test circuit for gate charge	-	8	-	nC
Q <sub>gd</sub>	Gate-drain charge	behavior")	-	18.5	-	

#### Notes:

 $^{(1)}$  Coss eq. is defined as a constant equivalent capacitance giving the same charging time as Coss when VDs increases from 0 to 80% VDSs.

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit	
t <sub>d(on)</sub>	Turn-on delay time	$V_{DD} = 300 \text{ V}, \text{ I}_{D} = 10.5 \text{ A}$	-	16	-		
tr	Rise time	$R_G = 4.7 \Omega$ , $V_{GS} = 10 V$ (see Figure 14: "Test circuit for	-	7.3	-		
t <sub>d(off)</sub>	Turn-off delay time	resistive load switching times"	-	53	-	ns	
t <sub>f</sub>	Fall time	and Figure 19: "Switching time waveform")	-	9.3	-		

**Table 7: Switching times** 





#### Electrical characteristics

	Table 8: Source-drain diode							
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit		
I <sub>SD</sub> <sup>(1)</sup>	Source-drain current		-		21	А		
I <sub>SDM</sub> <sup>(2)</sup>	Source-drain current (pulsed)		-		84	А		
Vsd <sup>(3)</sup>	Forward on voltage	V <sub>GS</sub> = 0 V, I <sub>SD</sub> = 21 A	-		1.6	V		
trr	Reverse recovery time	I <sub>SD</sub> = 21 A, di/dt = 100 A/µs,	-	140		ns		
Qrr	Reverse recovery charge	$V_{DD} = 60 V$ (see Figure 16: "Test circuit for inductive load	-	0.5		μC		
Irrm	Reverse recovery current	switching and diode recovery times")	-	7.4		А		
trr	Reverse recovery time	I <sub>SD</sub> = 21 A, di/dt = 100 A/µs,	-	309		ns		
Qrr	Reverse recovery charge	$V_{DD} = 60 \text{ V}, \text{ T}_{j} = 150 \text{ °C}$ (see Figure 16: "Test circuit for	-	2.6		μC		
Irrm	Reverse recovery current	inductive load switching and diode recovery times")	-	16.8		А		

### Notes:

<sup>(1)</sup> Limited by maximum junction temperature.

 $^{\left( 2\right) }$  Pulse width is limited by safe operating area.

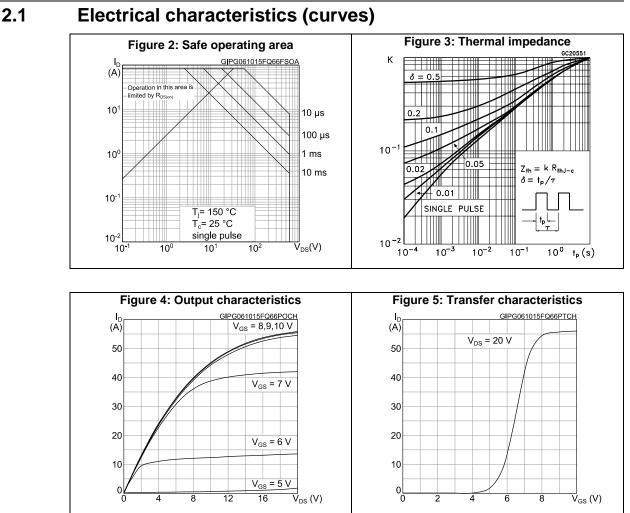
 $^{(3)}$  Pulse test: pulse duration = 300 µs, duty cycle 1.5%.

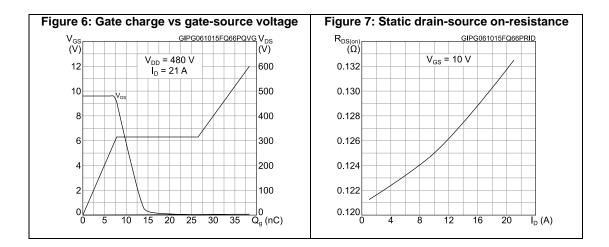
#### Table 9: Gate-source Zener diode

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V <sub>(BR)</sub> GSO	Gate-source breakdown voltage	$I_{GS} = \pm 250 \ \mu A, I_D = 0 \ A$	±30	-	-	V

The built-in back-to-back Zener diodes are specifically designed to enhance the ESD performance of the device. The Zener voltage facilitates efficient and cost-effective device integrity protection, thus eliminating the need for additional external componentry.



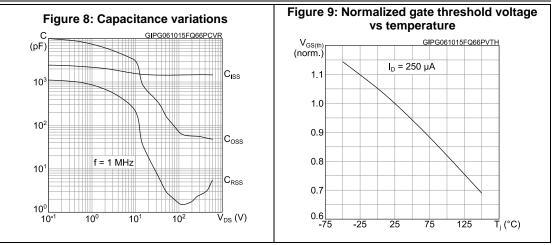


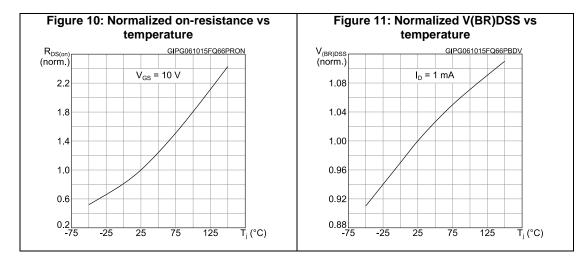


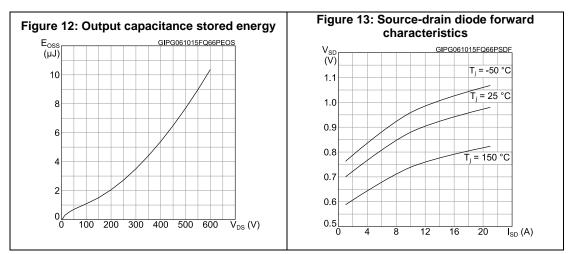
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#### **Electrical characteristics**

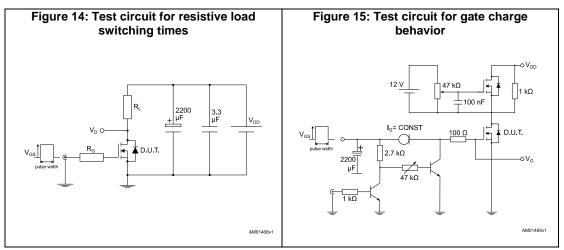


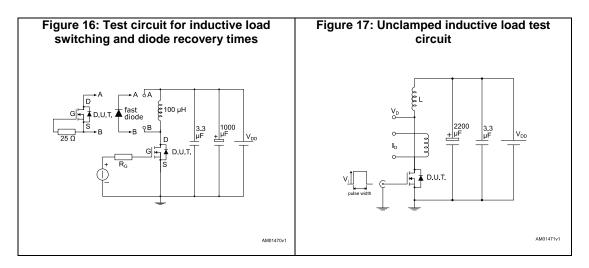


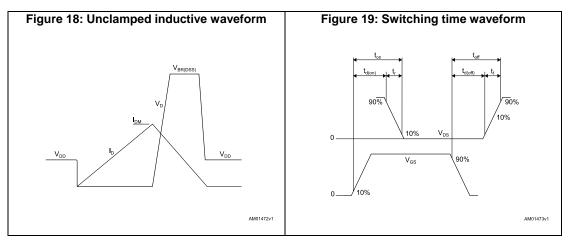


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## 3 Test circuits







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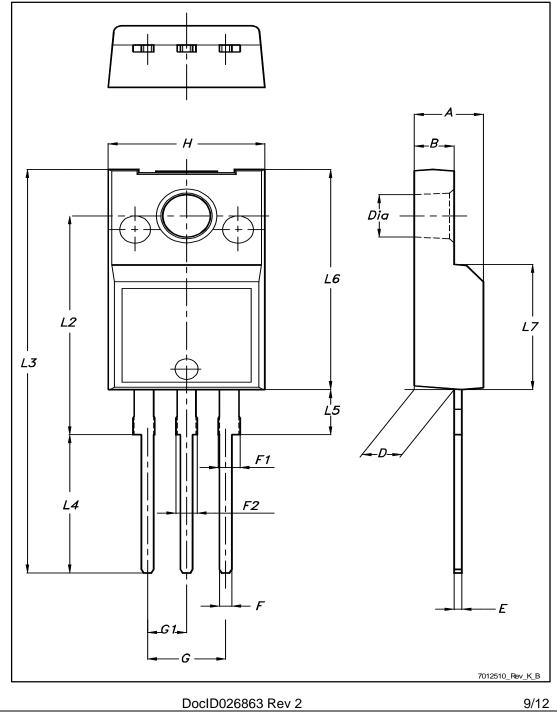
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## 4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK<sup>®</sup> packages, depending on their level of environmental compliance. ECOPACK<sup>®</sup> specifications, grade definitions and product status are available at: *www.st.com*. ECOPACK<sup>®</sup> is an ST trademark.

## 4.1 TO-220FP package information

Figure 20: TO-220FP package outline



### Package information

Table 10: TO-220FP package mechanical data

### STF28N60DM2

Dim		mm	
Dim.	Min.	Тур.	Max.
А	4.4		4.6
В	2.5		2.7
D	2.5		2.75
E	0.45		0.7
F	0.75		1
F1	1.15		1.70
F2	1.15		1.70
G	4.95		5.2
G1	2.4		2.7
Н	10		10.4
L2		16	
L3	28.6		30.6
L4	9.8		10.6
L5	2.9		3.6
L6	15.9		16.4
L7	9		9.3
Dia	3		3.2



# 5 Revision history

### Table 11: Document revision history

Date	Revision	Changes
04-Sep-2014	1	First release.
04-Sep-2014 09-Oct-2015	2	First release.   Text and formatting changes throughout document   On cover page:   - upated title and Features table   In section Electrical ratings:   - updated all table data   In section Electrical characteristics:   - updated all table data   - renamed table Static (was On /off states)   - added table Gate-source Zener diode   Added section Electrical characteristics (curves)   Updated and renamed section Package mechanical data (was Package information)
		Datasheet promoted from preliminary to production data



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